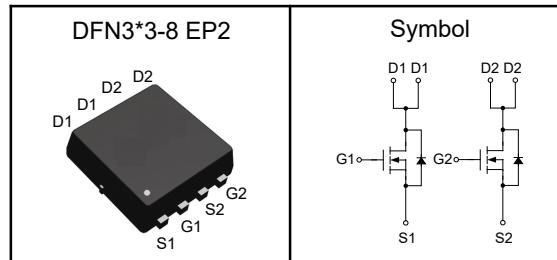


Dual N-Channel Enhancement Mode MOSFET

Features

- Fast switching speed
- Reliable and Rugged
- ROHS Compliant
- 100% Avalanche Tested

Pin Description



Applications

- Power Management in Desktop Computer
- DC/DC Converters

V _{DSS}	30	V
R _{DS(ON)-Typ}	7	mΩ
I _D	25	A

Absolute Maximum Ratings (T_C=25°C, Unless Otherwise Noted)

Symbol	Parameter	Rating	Unit
V _{DSS}	Drain-Source Voltage	30	V
V _{GSS}	Gate-Source Voltage	±20	V
T _J	Maximum Junction Temperature	-55 to 150	°C
T _{STG}	Storage Temperature Range	-55 to 150	°C
E _{AS}	Single Pulse Avalanche Energy	16	mJ
I _{DM} ^①	Pulse Drain Current Tested	100	A
I _D	Continuous Drain Current T _C =25°C	25	A
	Continuous Drain Current T _C =100°C	14	A
P _D	Maximum Power Dissipation T _C =25°C	16	W

Thermal Characteristics

Symbol	Parameter	Rating	Unit
R _{θJA}	Thermal Resistance-Junction to Ambient	55	°C/W
R _{θJC}	Thermal Resistance-Junction to Case	6.5	°C/W

Note ① : Max. current is limited by bonding wire.

Note ② : UIS tested and pulse width are limited by maximum junction temperature 150°C.

Note ③ : Surface Mounted on 1in² FR-4 board with 1oz.

Dual N-Channel Enhancement Mode MOSFET

Electrical Characteristics ($T_J=25^\circ\text{C}$, Unless Otherwise Noted)

Symbol	Parameter	Test Conditions	Min	Typ	Max	Unit
Static Electrical Characteristics						
BV_{DSS}	Drain-Source Breakdown Voltage	$V_{\text{GS}}=0\text{V}$, $I_{\text{D}}=250\mu\text{A}$	30	---	---	V
I_{DSS}	Zero Gate Voltage Drain Current	$V_{\text{DS}}=30\text{V}$, $V_{\text{GS}}=0\text{V}$	---	---	1	μA
$V_{\text{GS(th)}}$	Gate Threshold Voltage	$V_{\text{DS}}=V_{\text{GS}}$, $I_{\text{D}}=250\mu\text{A}$	1.4	---	1.9	V
I_{GSS}	Gate Leakage Current	$V_{\text{GS}}=\pm 20\text{V}$, $V_{\text{DS}}=0\text{V}$	---	---	± 100	nA
$R_{\text{DS(ON)}}$	Drain-Source On-state Resistance	$V_{\text{GS}}=10\text{V}$, $I_{\text{D}}=15\text{A}$	---	7	8.5	$\text{m}\Omega$
		$V_{\text{GS}}=4.5\text{V}$, $I_{\text{D}}=15\text{A}$	---	11	12.5	
Dynamic Characteristics^⑤						
C_{iss}	Input Capacitance	$V_{\text{GS}}=0\text{V}$, $V_{\text{DS}}=15\text{V}$, Freq.=1.0MHz	---	1330	---	pF
C_{oss}	Output Capacitance		---	102	---	
C_{rss}	Reverse Transfer Capacitance		---	105	---	
$T_{\text{d(on)}}$	Turn-on Delay Time	$V_{\text{GS}}=10\text{V}$, $V_{\text{DD}}=15\text{V}$, $I_{\text{D}}=20\text{A}$, $R_{\text{G}}=3\Omega$	---	5.8	---	nS
T_r	Turn-on Rise Time		---	56	---	
$T_{\text{d(off)}}$	Turn-off Delay Time		---	26	---	
T_f	Turn-off Fall Time		---	12	---	
Q_g	Total Gate Charge	$V_{\text{GS}}=10\text{V}$, $V_{\text{DD}}=15\text{V}$, $I_{\text{D}}=20\text{A}$	---	23	---	nC
Q_{gs}	Gate-Source Charge		---	4.2	---	
Q_{gd}	Gate-Drain Charge		---	5.6	---	
Source-Drain Characteristics						
V_{SD}	Diode Forward Voltage	$I_{\text{S}}=20\text{A}$, $V_{\text{GS}}=0\text{V}$	---	---	1.2	V
t_{rr}	Reverse recovery time	$I_{\text{F}}=20\text{A}$, $dI/dt=100\text{A}/\mu\text{s}$	---	6.8	---	ns
Q_{rr}	Reverse recovery charge		---	2.0	---	nC

Note ④: Pulse test (pulse width $\leq 300\mu\text{s}$, duty cycle $\leq 2\%$).

Note ⑤ : Guaranteed by design, not subject to production testing.

Dual N-Channel Enhancement Mode MOSFET

Typical Characteristics

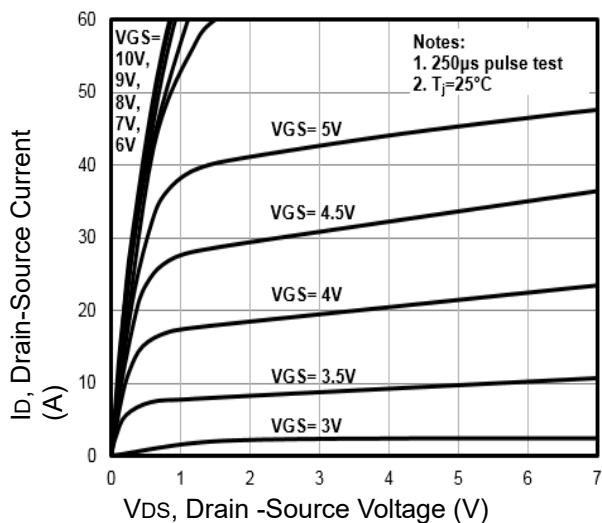


Fig1. Typical Output Characteristics

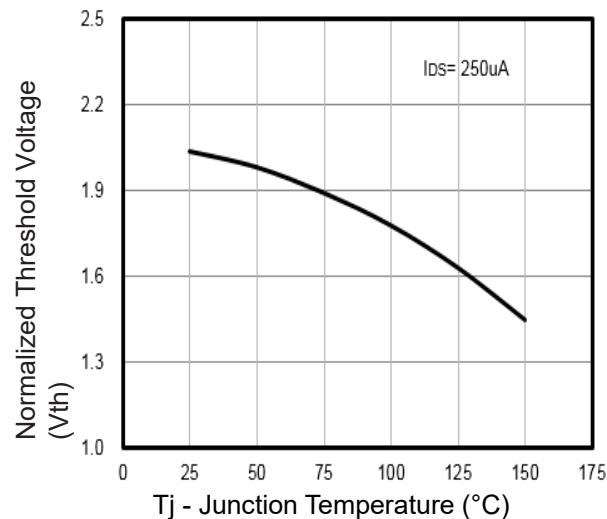


Fig2. Normalized Threshold Voltage Vs. Temperature

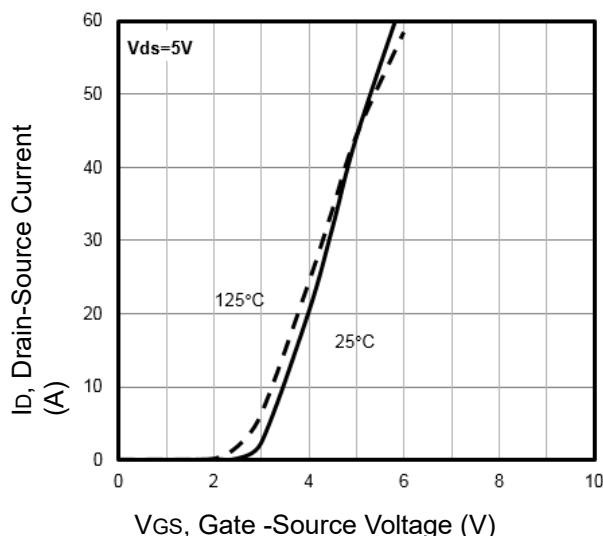


Fig3. Typical Transfer Characteristics

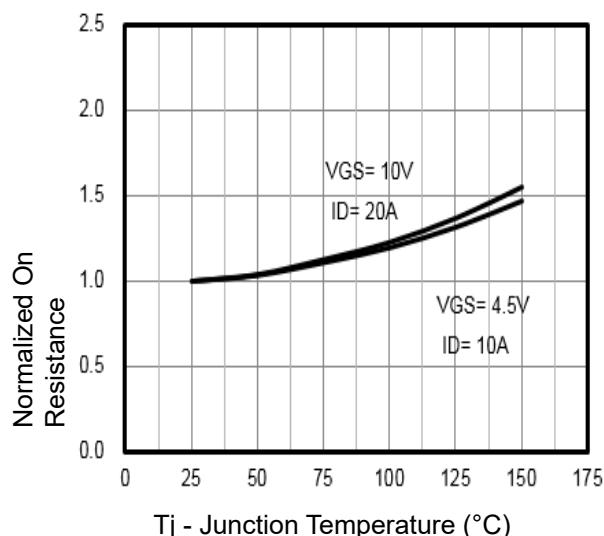


Fig4. Normalized On-Resistance Vs. Temperature

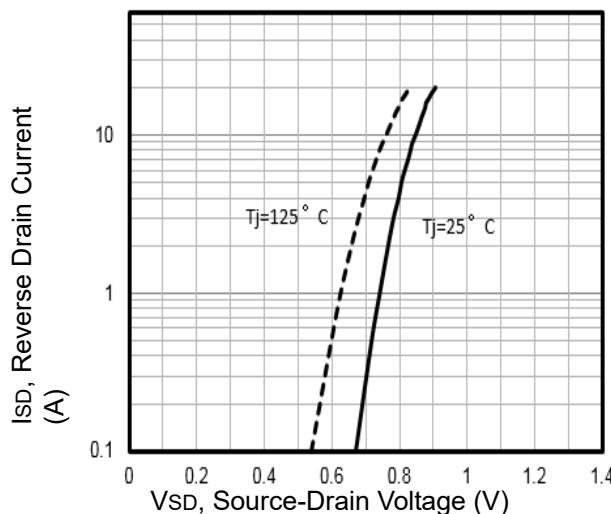


Fig5. Typical Source-Drain Diode Forward Voltage

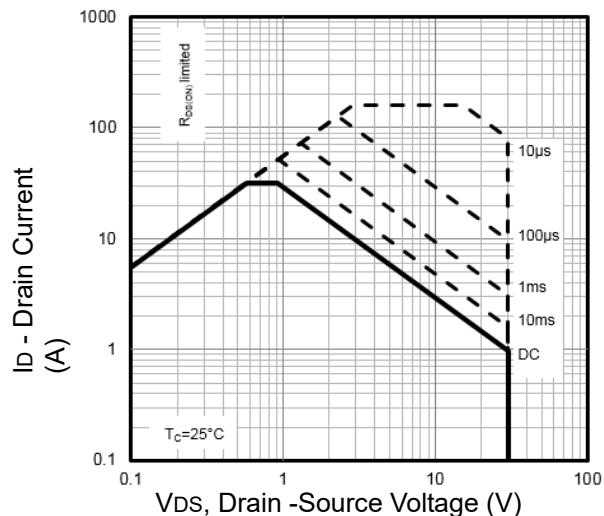


Fig6. Maximum Safe Operating Area

Dual N-Channel Enhancement Mode MOSFET

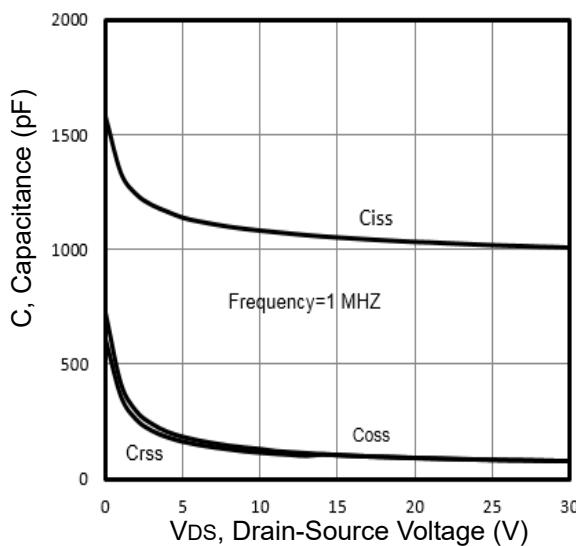


Fig7. Typical Capacitance Vs. Drain-Source Voltage

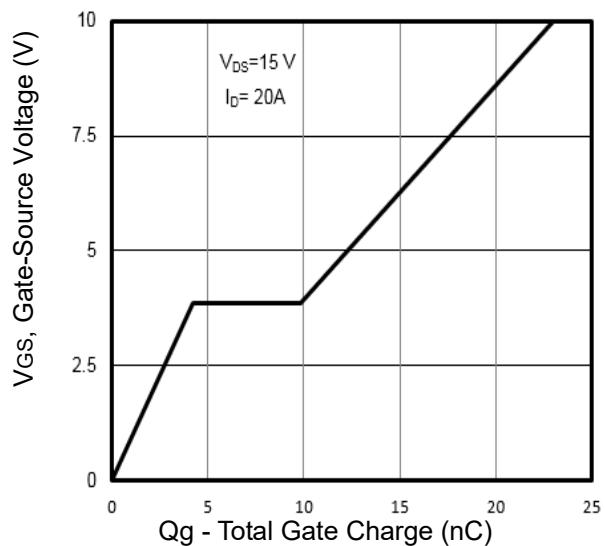


Fig8. Typical Gate Charge Vs. Gate-Source

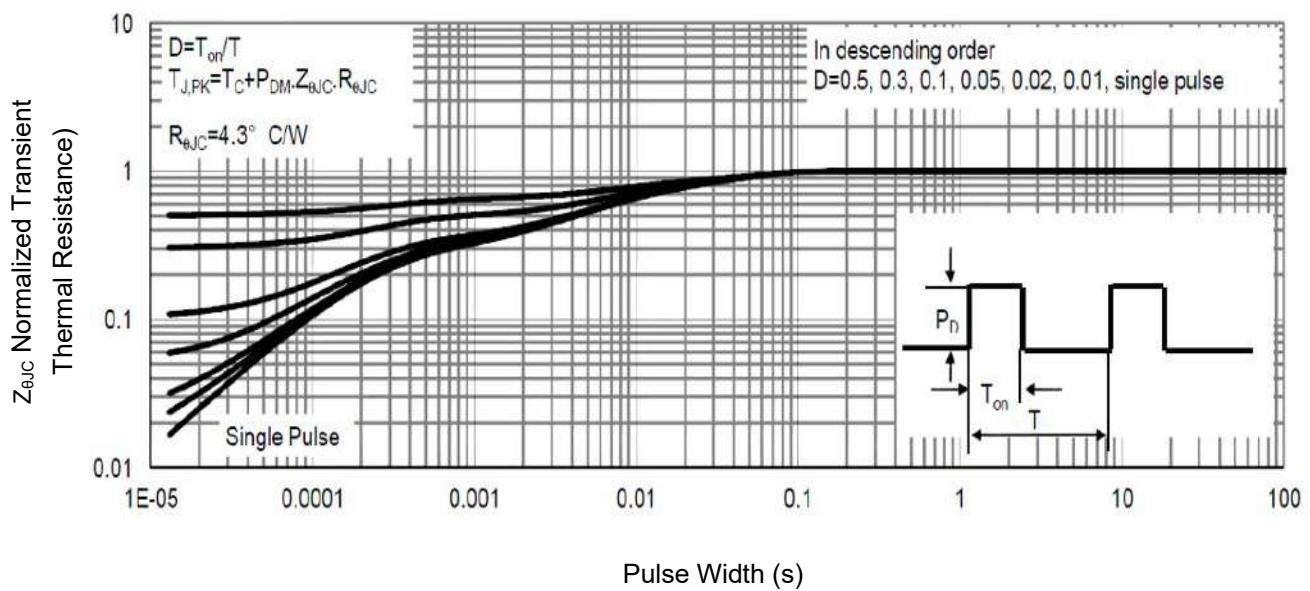
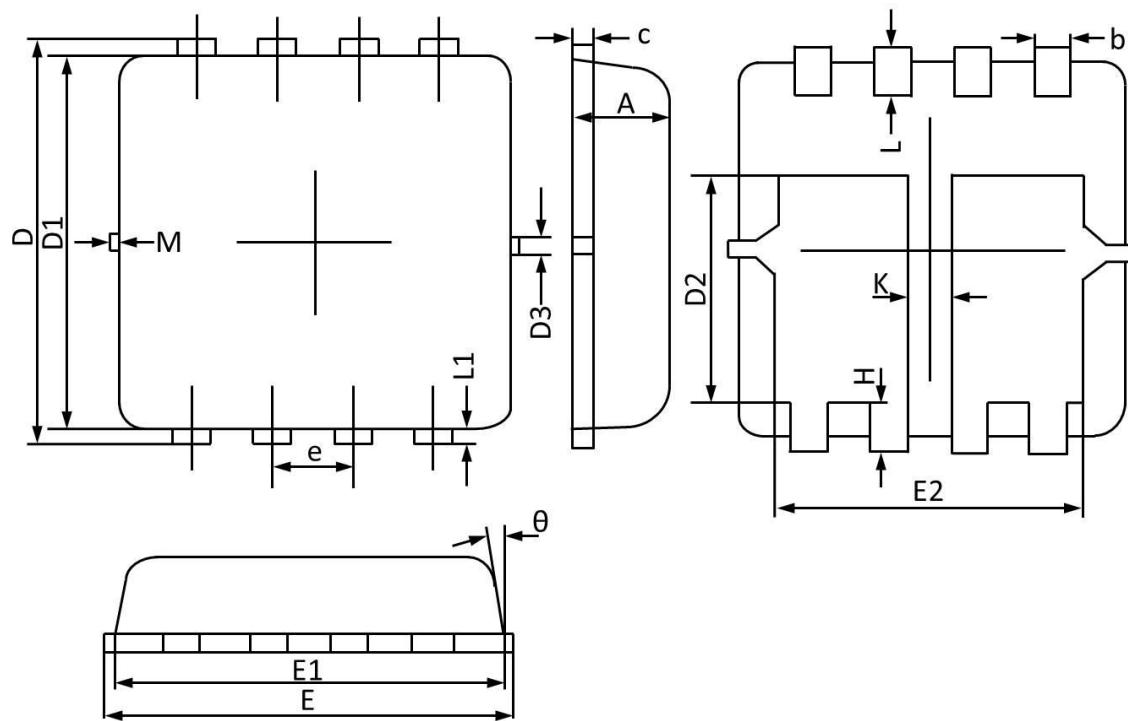


Fig9. Normalized Maximum Transient Thermal Impedance

Dual N-Channel Enhancement Mode MOSFET

DFN3*3-8 EP2 Package Outline Data



Symbol	Dimensions (unit:mm)			Symbol	Dimensions (unit:mm)		
	Min	Typ	Max		Min	Typ	Max
A	0.70	0.75	0.85	E2	2.35	2.50	2.60
b	0.25	0.30	0.35	e	0.65 BSC		
c	0.10	0.17	0.25	H	0.30	0.40	0.50
D	3.10	3.30	3.45	L	0.30	0.40	0.50
D1	2.90	3.05	3.20	L1	0.13 REF		
D2	1.45	1.70	1.95	K	0.30 REF		
D3	0.13 REF			θ	0°	12°	
E	3.05	3.25	3.40	M	0.15 REF		
E1	2.90	3.10	3.25				